

Preliminary

Toshiba Bi-CMOS Integrated Circuit Silicon Monolithic

TB6549F/FG, TB6549P/PG

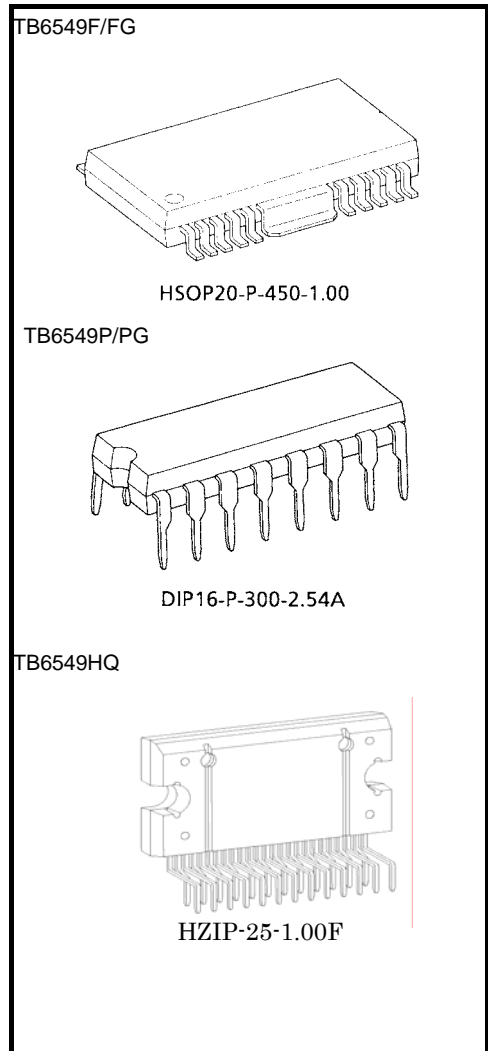
*TB6549HQ (TB6549HQ: In development)

Full-Bridge Driver IC for DC Motors

The TB6549F/FG/P/PG/HQ is a full-bridge driver IC for DC motors that uses an LDMOS structure for output transistors. High-efficiency drive is possible through the use of a MOS process with low ON-resistance and a PWM drive system. Four modes, CW, CCW, short brake, and stop, can be selected using IN1 and IN2.

Features

- Power supply voltage: 30 V (max)
- Output current: 3.5 A (max) (F/FG,P/PG type) / 4.5 A (max.) (HQ type)
- Low ON-resistance: 0.5 Ω (typ.)
- PWM control capability
- Standby system
- Function modes: CW/CCW/short brake/stop
- Built-in overcurrent protection
- Built-in thermal shutdown circuit
- Package: HSOP-20/DIP-16

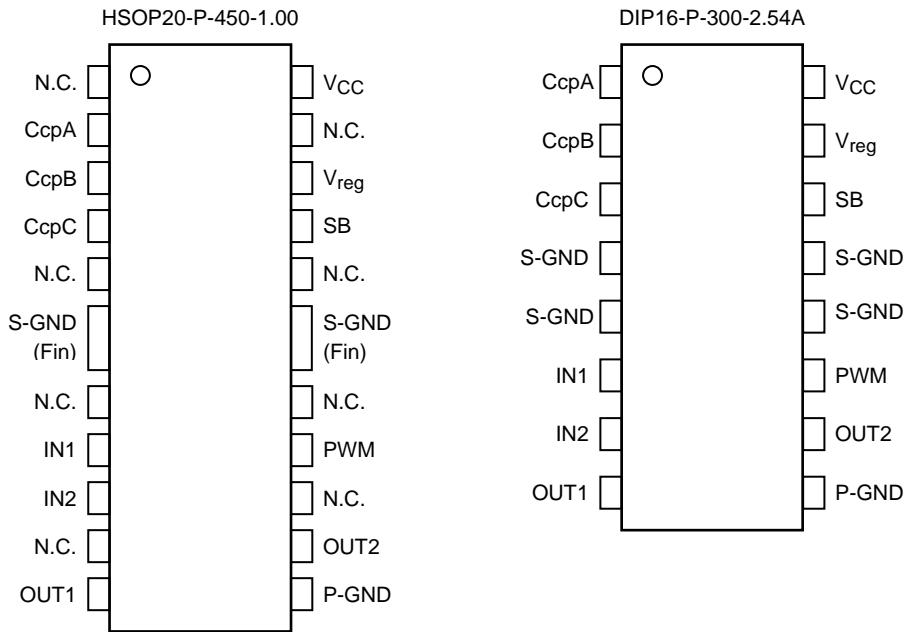


TB6549FG/PG/HQ:
 The TB6549FG/PG is a Pb-free product.
 The TB6549HQ is a Sn-Ag plated product including Pb.
 The following conditions apply to solderability:
 *Solderability

1. Use of Sn-37Pb solder bath
 - *solder bath temperature = 230°C
 - *dipping time = 5 seconds
 - *number of times = once
 - *use of R-type flux
2. Use of Sn-3.0Ag-0.5Cu solder bath
 - *solder bath temperature = 245°C
 - *dipping time = 5 seconds
 - *number of times = once
 - *use of R-type flux

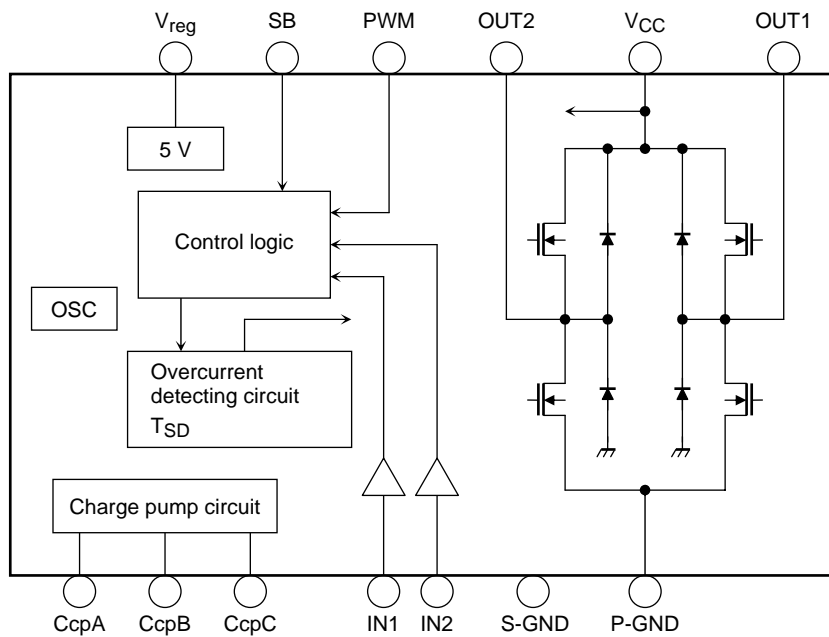
Weight
 HSOP20-P-450-1.00: 0.79 g (typ.)
 DIP16-P-300-2.54A: 1.11 g (typ.)
 HZIP-25-1.00F: 7.7g (typ.)

Pin Assignment



Note: This product has a MOS structure and is sensitive to electrostatic discharge. When handling this product, ensure that the environment is protected against electrostatic discharge by using an earth strap, a conductive mat and an ionizer. Ensure also that the ambient temperature and relative humidity are maintained at reasonable levels.

Block Diagram



Pin Functions

Pin No.			Pin Name	Functional Description	Remarks
F/FG	P/PG	HQ			
1	—	—	(NC)	No Connection	—
2	1	14	CcpA	Capacitor connection pin for charge pump A	Connect a capacitor for charge pump
3	2	15	CcpB	Capacitor connection pin for charge pump B	Connect a capacitor for charge pump
4	3	16	CcpC	Capacitor connection pin for charge pump C	Connect a capacitor for charge pump
5	—	—	(NC)	No Connection	—
6	—	—	(NC)	No Connection	—
7	6	23	IN1	Control signal input 1	Input 0/5-V signal
8	7	24	IN2	Control signal input 2	Input 0/5-V signal
9	—	—	(NC)	No Connection	—
10	8	25	OUT1	Output pin 1	Connect to motor coil pin
11	9	1	P-GND	Power GND	—
12	10	2,5	OUT2	Output pin 2	Connect to motor coil pin
13	—	—	(NC)	No Connection	—
14	11	3	PWM	PWM control signal input pin	Input 0/5-V PWM signal
15	—	—	(NC)	No Connection	—
16	—	—	(NC)	No Connection	—
17	14	10	SB	Standby pin	H: Start, L: Standby
18	15	11	V _{reg}	5 V output pin	Connect a capacitor to S-GND
19	—	—	(NC)	No Connection	—
20	16	12	V _{CC}	Power supply input pin	V _{CC (ope)} = 10 to 27 V
FIN	4, 5, 12, 13	7, 16	S-GND	GND pin	—

*) (HQ type) 4, 6, 8, 9, 13, 17, 18, 20, 21, 22 ;N.C.

Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Supply voltage		V _{CC}	30	V
Output current	I _O (Peak)	F/FG, P/PG	3.5 (Note 1)	A
		HQ	(5.0)	
	I _O (Ave)	F/FG, P/PG	2.0	
		HQ	(3.0)	
Power dissipation	F/FG	P _D	2.5 (Note 2)	W
	P/PG		2.5 (Note 3)	
	HQ			
Operating temperature		T _{opr}	-20 to 85	°C
Storage temperature		T _{stg}	-55 to 150	°C

Note 1: The maximum ratings must be observed strictly. Make sure that no characteristic listed above ever exceeds the maximum rating.

Note 2: This value is obtained for a 115 × 75 × 1.6 mm PCB mounting with 30% copper area.

Note 3: This value is obtained for a 50 × 50 × 1.6 mm PCB mounting with 50% copper area.

Operating Range (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Supply voltage	V _{CC}	10 to 27	V
PWM frequency	f _{CLK}	100	kHz

Electrical Characteristics (V_{CC} = 24 V, Ta = 25°C)

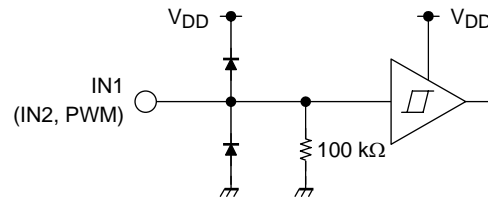
Characteristic		Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit	
Supply current		I _{CC1}	1	Stop mode	—	4	8	mA	
		I _{CC2}		CW/CCW mode	—	6	10		
		I _{CC3}		Short break mode	—	4	8		
		I _{CC4}		(Standby mode)	—	1	2		
Control circuit		V _{INH}	2		2	—	5.5	V	
		V _{INL}			—	—	0.8		
		Hysteresis voltage	V _{IN (HYS)}	—	(Not tested)	—	0.2	—	μA
		Input current	I _{INH}	1	V _{IN} = 5 V	—	50	75	
I _{INL}	V _{IN} = 0 V		—		—	5			
PWM input circuit		Input voltage	3		2	—	5.5	V	
					V _{PWML}	—	—		0.8
		Hysteresis voltage	V _{PWM(HYS)}	—	(Not tested)	—	0.2	—	μA
		Input current	I _{PWMH}	3	V _{PWM} = 5 V	—	50	75	
			I _{PWML}		V _{PWM} = 0 V	—	—	5	
PWM frequency	f _{PWM}	3	Duty = 50%	—	—	100	kHz		
Minimum clock pulse width	tw(PWM)			2	—	—	μs		
Standby circuit		Input voltage	2		2	—	5.5	V	
					V _{INSL}	—	—		0.8
		Hysteresis voltage	V _{IN (HYS)}	—	(Not tested)	—	0.2	—	μA
		Input current	I _{INSH}	1	V _{IN} = 5 V	—	50	75	
I _{INSL}	V _{IN} = 0 V		—		—	5			
Output ON-resistance		R _{ON (U + L)}	4		I _o = 0.2 A	—	1.0	1.75	Ω
					I _o = 1.5 A	—	1.0	1.75	
Output leakage current		I _{L (U)}	5	V _{CC} = 30 V (Note 1)	—	—	150	μA	
		I _{L (L)}			V _{CC} = 30 V	—	—		10
Diode forward voltage		V _{F (U)}	6	I _o = 1.5 A	—	1.3	1.7	V	
		V _{F (L)}			I _o = 1.5 A	—	1.3		1.7
Internal reference voltage		V _{reg}	4	No load	4.5	5	5.5	V	
Overcurrent detection offset time		I _{SD (OFF)}	—	(Not tested)	—	50	—	μs	
Charge pump rising time		t _{ONG}	7	C ₁ = 0.22 μF, C ₂ = 0.01 μF (Note 2)	—	1	3	ms	
Thermal shutdown circuit operating temperature		T _{SD}	—	(Not tested)	—	160	—	°C	

Note 1: Include the current in the circuit.

Note 2: C₁ is a capacitor between CcpA and GND. C₂ is a capacitor between CcpB and CcpC.

Component Description

1. Control Input/PWM Input Circuit



- The input signals are shown below. Input at the CMOS and TTL levels can be provided. Note that the input signals have a hysteresis of 0.2 V (typ.).

V_{INH} : 2 to V_{reg} V

V_{INL} : GND to 0.8 V

- The PWM input frequency should be 100 kHz or less.

Input/Output Function

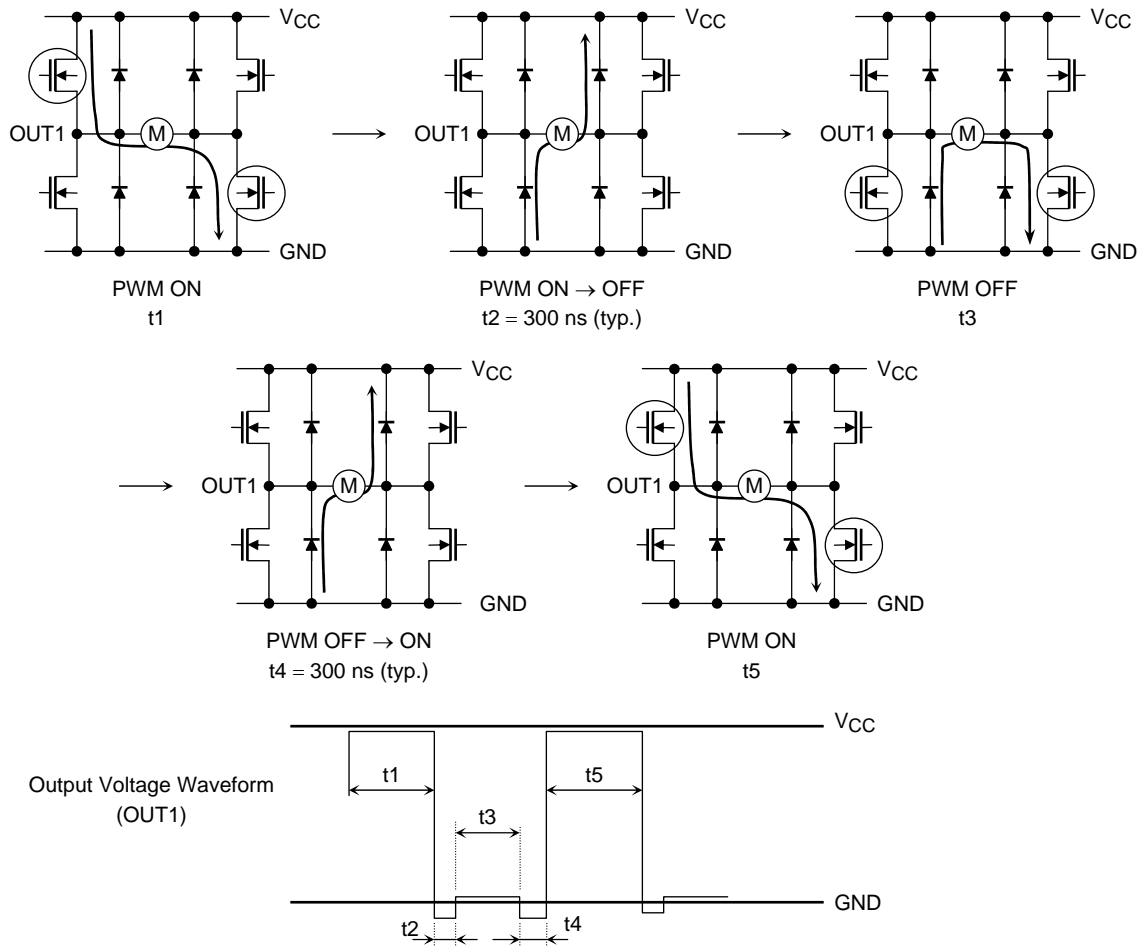
Input				Output		
IN1	IN2	SB	PWM	OUT1	OUT2	Mode
H	H	H	H	L	L	Short brake
			L			
L	H	H	H	L	H	CW/CCW
			L		L	Short brake
H	L	H	H	H	L	CCW/CW
			L	L	L	Short brake
L	L	H	H	OFF (high impedance)		Stop
			L			
H/L	H/L	L	H	OFF (high impedance)		Standby
			L			

- PWM control function

Motor speed can be controlled by inputting the 0/5-V PWM signal to the PWM pin.

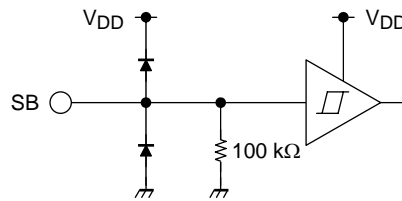
When PWM control is provided, normal operation and short brake operation are repeated.

If the upper and lower power transistors in the output circuit were ON at the same time, a penetrating current would be produced. To prevent this current from being produced, a dead time of 300 ns (design target value) is provided in the IC when either of the transistors changes from ON to OFF, or vice versa. Therefore, PWM control by synchronous rectification is enabled without an OFF time being inserted by external input. Note that a dead time is also provided in the IC at the time of transition between CW and CCW or between CW (CCW) and short brake mode, thereby eliminating the need for an OFF time.



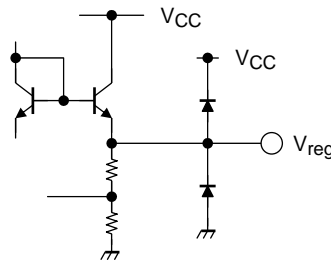
Note: Be sure to set the pin PWM to High when the PWM control function is not used.

2. Standby Circuit



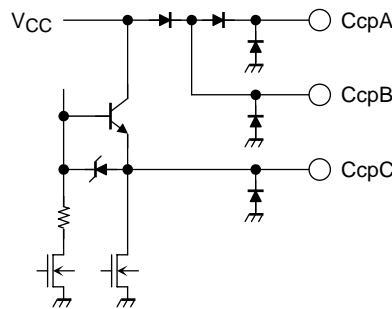
- All circuits are turned off except the standby circuit and the charge pump circuit under the standby condition.
- The input voltage range is shown below. Input at CMOS and TTL level is possible. The input signal has 0.2 V (typ.) hysteresis.
 VINSH: 2 to V_{reg} V
 VINSL: GND to 0.8 V
- Do not attempt to the control the output by inputting PWM signals to the standby pin. Doing so may cause the output signal to become unstable, resulting in destruction of the IC.
- The charge pump circuit is turned ON/OFF by the switch of the input signal from the standby pin. If the switching cycle is shorter than 50 ms, the charge pump circuit will not operate with precise timing. Therefore the switching cycle of the standby pin should be longer than 50 ms.
- When the Standby condition is changed to Operation Mode, set IN1 and IN2 to Low level (Stop Mode) at first. Then switch IN1 and IN2 to High level when the charge pump circuit reaches the stable condition, i.e., when V_{cpA} is about $V_{CC} + 5$ V.

3. Internal Constant-Voltage (5 V) Circuit



- This IC includes a 5 V power supply for control circuit.
- A capacitor for prevention of oscillation should be connected to S-GND associated with the pin V_{reg}. No other loads should be connected to pin V_{reg}.
- This IC has a power monitoring function and turns the output OFF when V_{reg} goes down to 3.0 V (design target value) or less. With a hysteresis of 0.3 V (design target value), the output are turned ON when V_{reg} again reaches 3.3 V (design target value).

4. Charge Pump Circuit



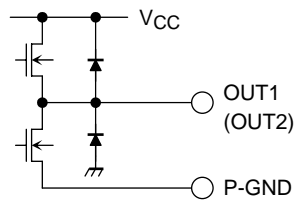
- This IC has a charge pump circuit for driving the gate for the upper power transistor in the output circuit. A voltage of V_{CC} + 5 V (typ.) is generated by connecting an external capacitor to this IC. It takes about 2 ms to boost V_{CpA} up V_{CC} + 5 V (typ.) after the switching of the input signal from the standby pin (while C_{cpA} = 0.22 μF, and C_{cpB} and C_{cpC} are connected through 0.01 μF).
- The proper capacitance of the external capacitor varies depending on the V_{CC} value. Thus, determine the constant by referring to the following data. The value of the capacitor between C_{cpB} and C_{cpC} should be such that, while the motor is being driven, the voltage on the C_{cpA} pin will be kept constant, typically at V_{CC} + 5 V. (If a reduced V_{CC} level causes the voltage on C_{cpA} to start to fall, please adjust this capacitance value accordingly.)

<External capacitor>

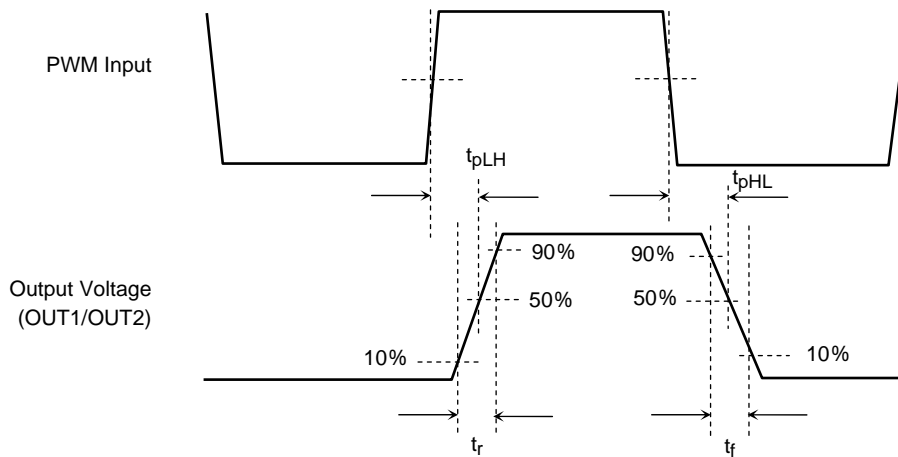
V _{CC}	Between CcpB and CcpC	Between CcpA and GND
10 V~15 V	0.01 μF~0.047 μF	0.22 μF
15 V~27 V	0.01 μF	0.22 μF

- Reference oscillation is performed by using the internal capacitor.

5. Output Circuit



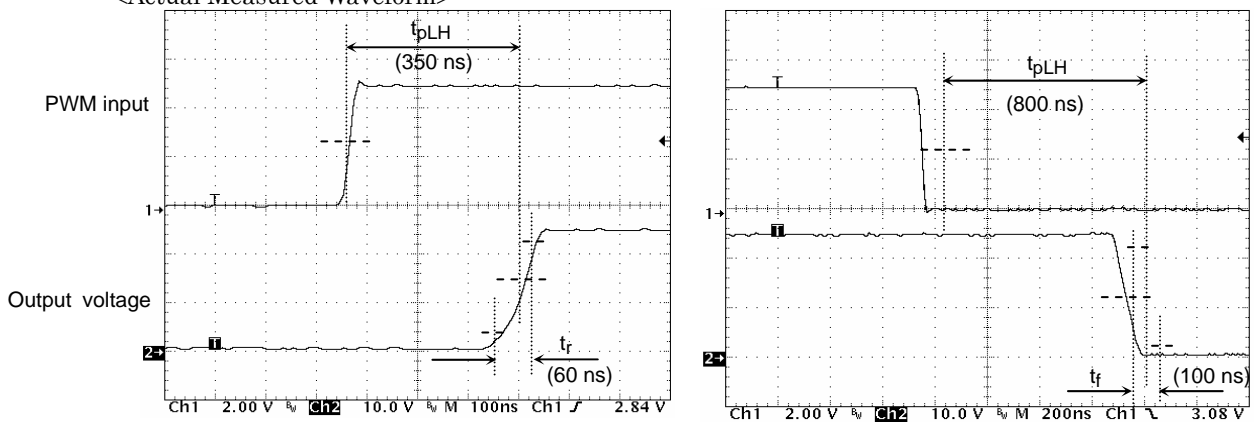
- This IC uses Nch MOS transistors as the upper and lower transistors in the output circuit.
- As output R_{on} is $1\ \Omega$ (sum for the upper and lower parts/typ.), this IC is a device of the low- R_{on} type.
- The switching characteristics of the output transistors are shown below.



<Typical Value>

Item	Typical Value	Unit
t_{pLH}	350	ns
t_{pHL}	800	
t_r	60	
t_f	100	

<Actual Measured Waveform>



*: OUT 1, OUT 2; open

6. VCC Power Supply Section

- The VCC power supply delivers a voltage to the output circuit, charge pump circuit, and internal 5 V circuit.
- The operating voltage range is shown below:
 $V_{CC (opr.)} = 10 \text{ to } 27 \text{ V}$
- This IC has a power monitoring function for preventing an output malfunction on power-up. However, Toshiba recommends that IN1, IN2, and SB be set to the Low level at power-on.

7. GND Sections

- This IC includes two separate GND sections: S-GND for controlling and P-GND for outputting. Be sure to short-circuit these two GNDs as close to TB6549 as possible.

8. Power Monitoring Circuit

- This circuit turns the output OFF when V_{reg} becomes 3.0 V (design target value) or less. At this time, $V_{CC} = 4.6 \text{ V (typ.)}$.
- With a hysteresis of 0.3 V (design target value), the output turns back ON when V_{reg} exceeds 3.3 V (design target value) after this circuit starts operating.

9. Thermal Shutdown (TSD) Circuit

This IC includes a thermal shutdown circuit, which turns the output OFF when the junction temperature (T_j) exceeds 160°C (typ.). The output turns back ON automatically. The thermal hysteresis is 20°C.

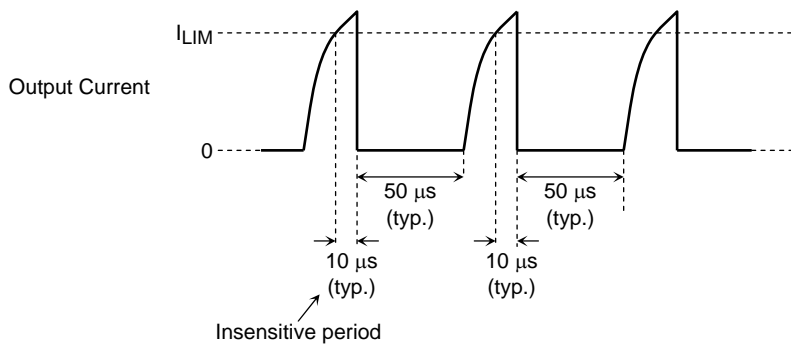
$$T_{SD} = 160^\circ\text{C (design target value)}$$

$$\Delta T_{SD} = 20^\circ\text{C (design target value)}$$

10. Overcurrent Detection (ISD) Circuit

This IC includes a circuit to detect current flowing through the output power transistors. The current limit is set to 5 A (typ.). The circuit detects a current flowing through each of the four output power transistors. If the current in any one output power transistor exceeds the set limit, this circuit turns all the outputs OFF.

This circuit includes a timer that causes the outputs to be OFF for 50 μs (typ.) after detection of an overcurrent and then turn back ON automatically. If the overcurrent continues to flow, this ON-OFF operation is repeated. Note that to prevent a malfunction due to a glitch, an insensitive period of 10 μs (typ.) is provided.



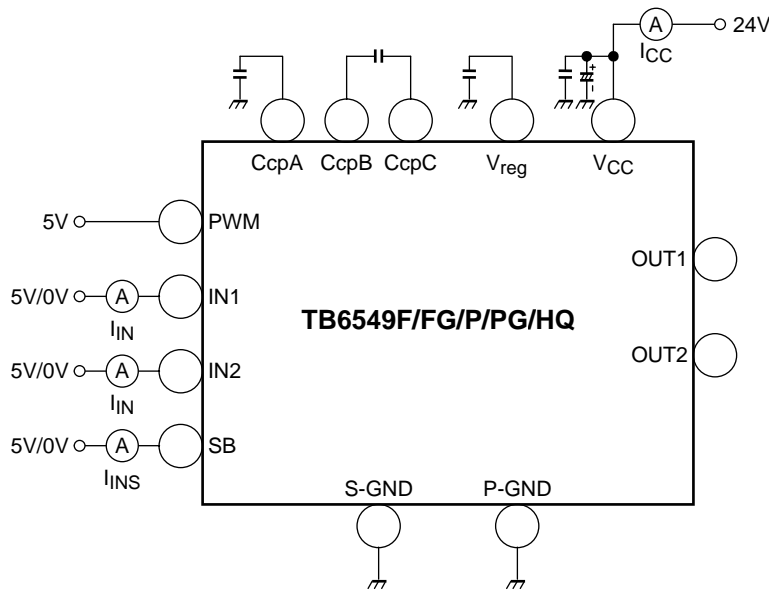
The set limit is 5 A (typ.) as a design target value. The distributions shown below exist because of the variations in thermal characteristics of different ICs. These distributions should be fully considered in the motor torque design.

Also, output peak current should be less than 3 A because of the variations below,

Detected current: Approximately from 3.5 to 6.5 A

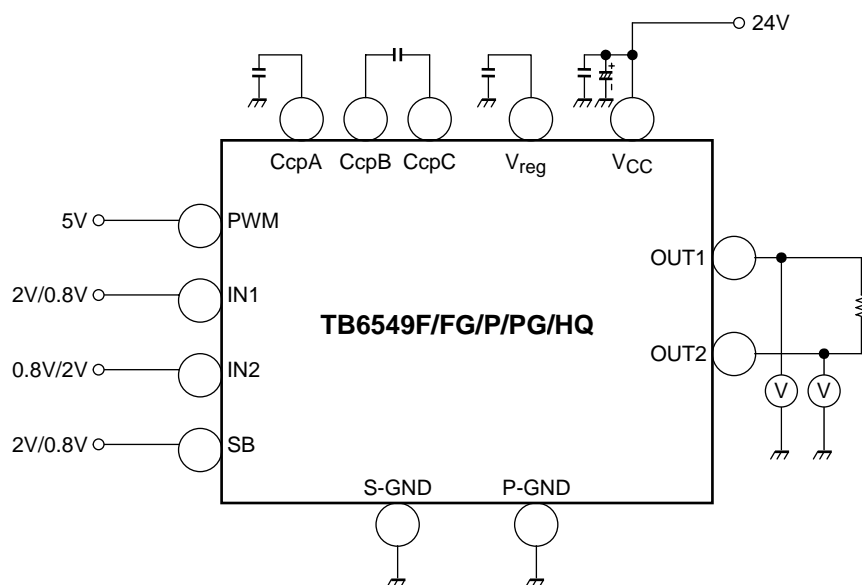
Test Circuit

1. I_{cc1} , I_{cc2} , I_{cc3} , I_{cc4} , I_{INH} , I_{INL} , I_{INSH} , I_{INSL}



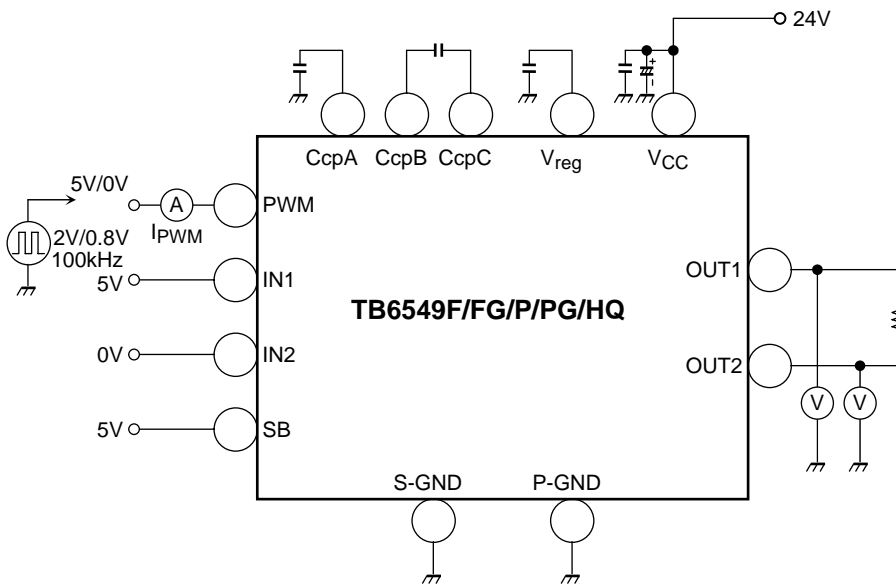
- I_{cc1} : $IN1 = 0\text{ V}$, $IN2 = 0\text{ V}$, $SB = 5\text{ V}$
- I_{cc2} : $IN1 = 5\text{ V}$, $IN2 = 5\text{ V}$, $SB = 5\text{ V}$ or $IN1 = 0\text{ V}$, $IN2 = 5\text{ V}$, $SB = 5\text{ V}$
- I_{cc3} : $IN1 = 5\text{ V}$, $IN2 = 5\text{ V}$, $SB = 5\text{ V}$
- I_{cc4} : $IN1 = 5\text{ V}/0\text{ V}$, $IN2 = 5\text{ V}/0\text{ V}$, $SB = 0\text{ V}$
- I_{INH} : $IN1 = 5\text{ V}$, and $IN2 = 5\text{ V}$
- I_{INL} : $IN2 = 0\text{ V}$, and $IN2 = 0\text{ V}$
- I_{INSH} : $SB = 5\text{ V}$
- I_{INSL} : $SB = 0\text{ V}$

2. V_{INH} , V_{INL} , V_{INSH} , V_{INSL}



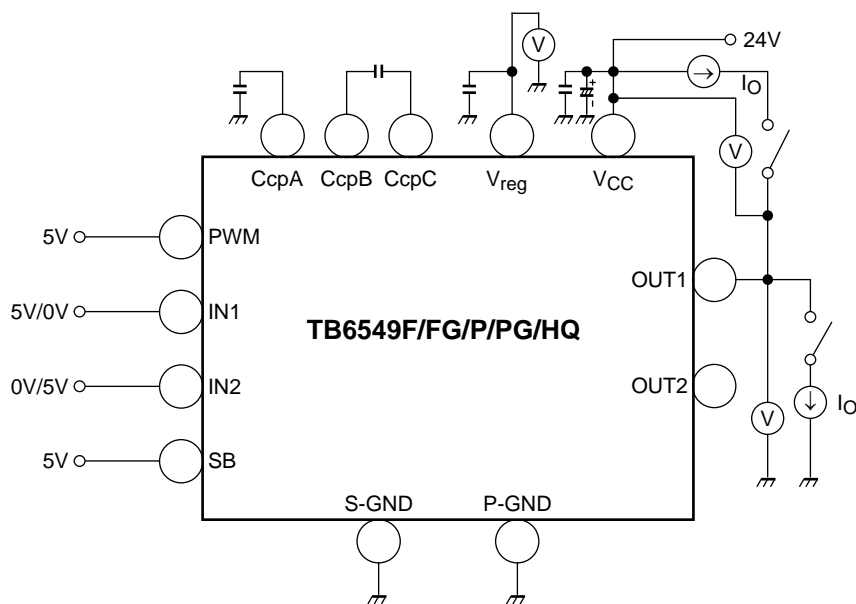
- V_{INH} , V_{INSH} : $IN1 = IN2 = SB = 2\text{ V}$. Verify that $OUT1 = OUT2 = L$.
- V_{INL} : $IN1 = 0.8\text{ V}$, $IN2 = SB = 2\text{ V}$. Verify that $OUT1 = L$, $OUT2 = H$. $IN1 = SB = 2\text{ V}$, $IN2 = 0.8\text{ V}$. Verify that $OUT1 = OUT2 = L$.
- V_{INSL} : $IN1 = IN2 = 2\text{ V}$, $SB = 0.8\text{ V}$. Verify that the output function is high impedance.

3. V_{PWMH} , V_{PWML} , I_{PWMH} , I_{PWML} , f_{PWM} , t_w (PWM)



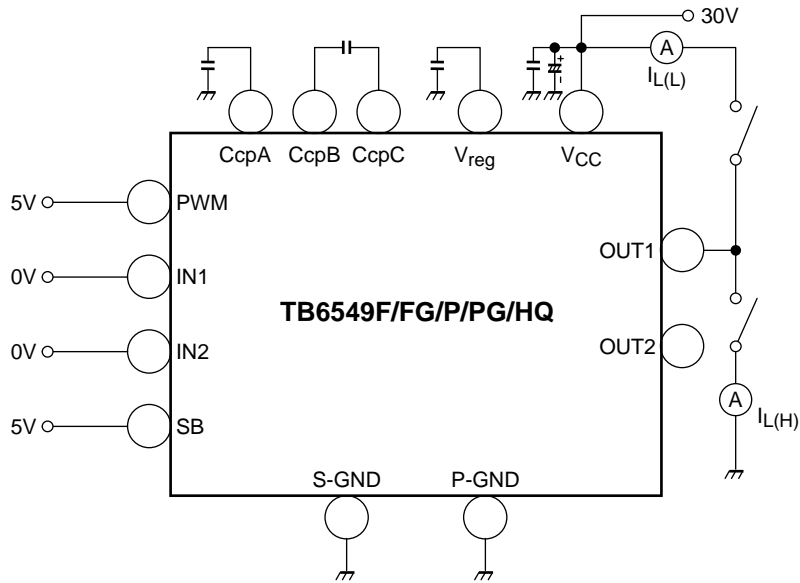
- V_{PWMH} , V_{PWML} , f_{PWM} : PWM = 2 V/0.8 V, 100 kHz; duty: 50 % (rectangular wave). Verify OUT1.
- V_{PWMH} , V_{PWML} : PWM = 5 V or PWM = 0 V.
- t_w (PWM): PWM = 2 V/0.8 V, 100 kHz; duty: 20 % (2 μ s) (2 μ s/rectangular wave). Verify OUT1.

4. R_{on} (H + L), V_{reg}

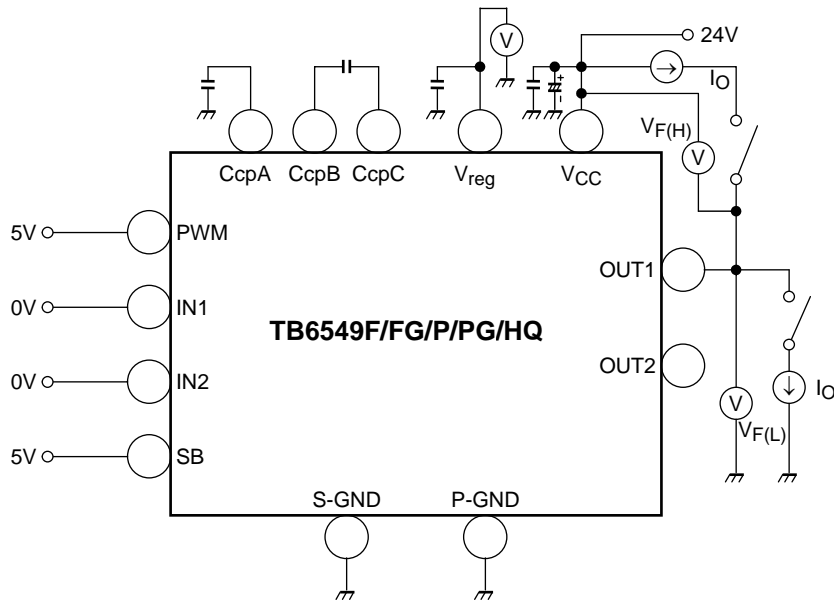


- R_{on} (H + L): Measure V_d s (the sum of upper and lower sides) at $I_o = 0.2$ A, and convert to resistor. Do the same at $I_o = 1.5$ A.
- V_{reg} : V_{reg} pin voltage.

5. $I_L(U)$, $I_L(L)$

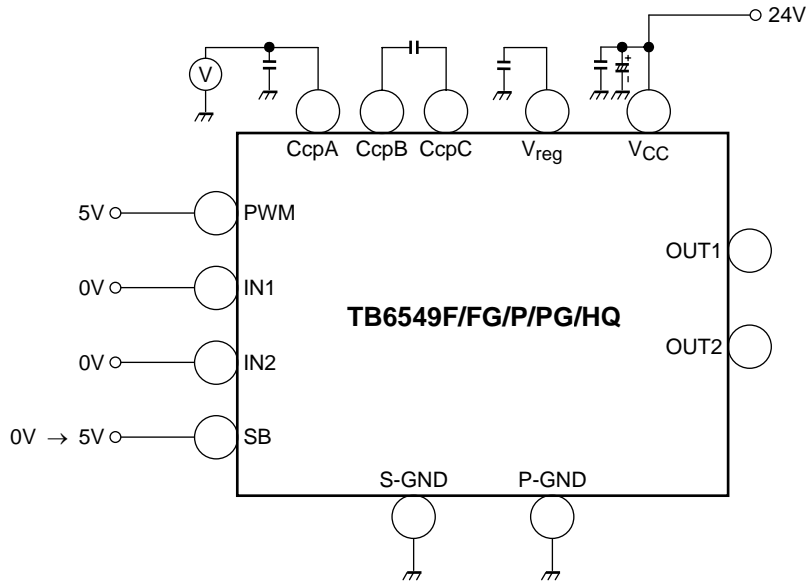


6. $V_F(U)$, $V_F(L)$

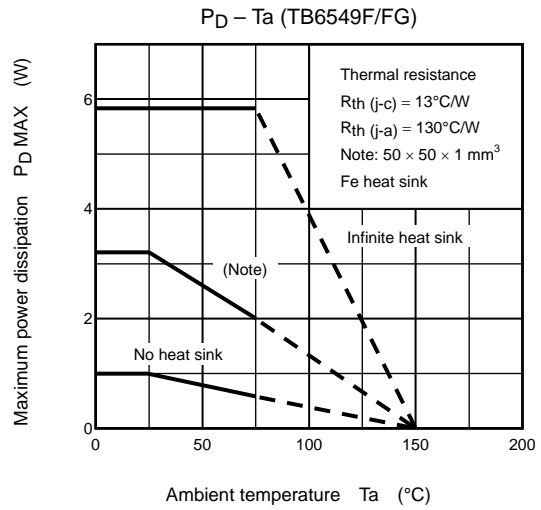
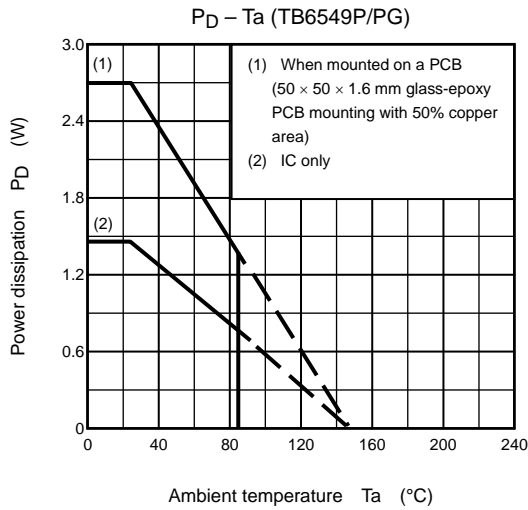


- $V_F(U)$, $V_F(L)$: $I_o = 1.5\text{ A}$.

7. t_{ONG}



- t_{ONG}: SB = 0 V → 5 V. Measure the time taken to boost the CcpA voltage up to about 29 V (24 V + 5 V).



External Attachments

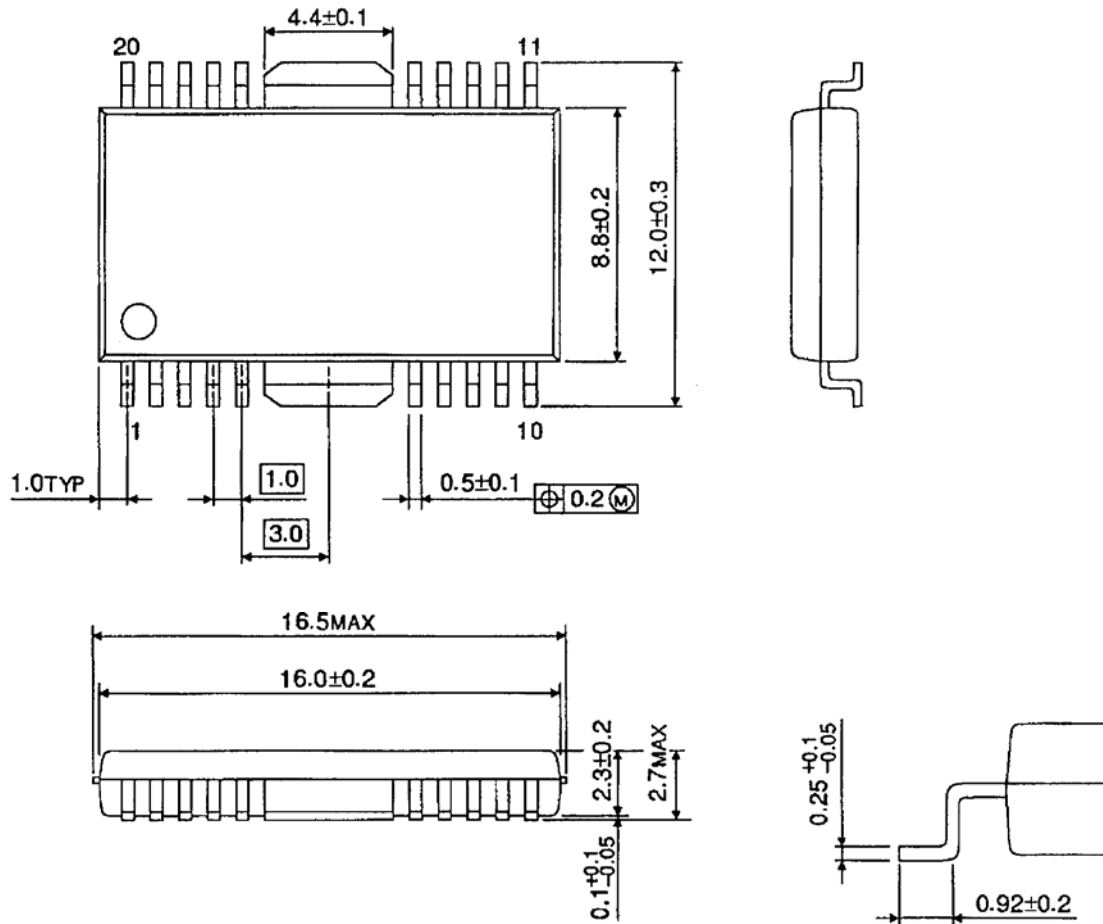
Symbol	Use	Recommended Value	Remarks
C ₁	Charge pump	0.22 μF	—
C ₂	Charge pump	0.01 μF	V _{CC} = 24 V (Note)
		0.033 μF	V _{CC} = 12 V (Note)
C ₃	Prevention of V _{reg} oscillation	0.1 μF to 1.0 μF	—
C ₄	Absorption of power noise	0.001 μF to 1 μF	—
C ₅	Absorption of power noise	50 μF to 100 μF	—

Note: The recommended values for charge pumps depend on the V_{CC} value. Refer to Component Description 4, Charge Pump Circuit.

Package Dimensions

HSOP20-P-450-1.00

Unit : mm

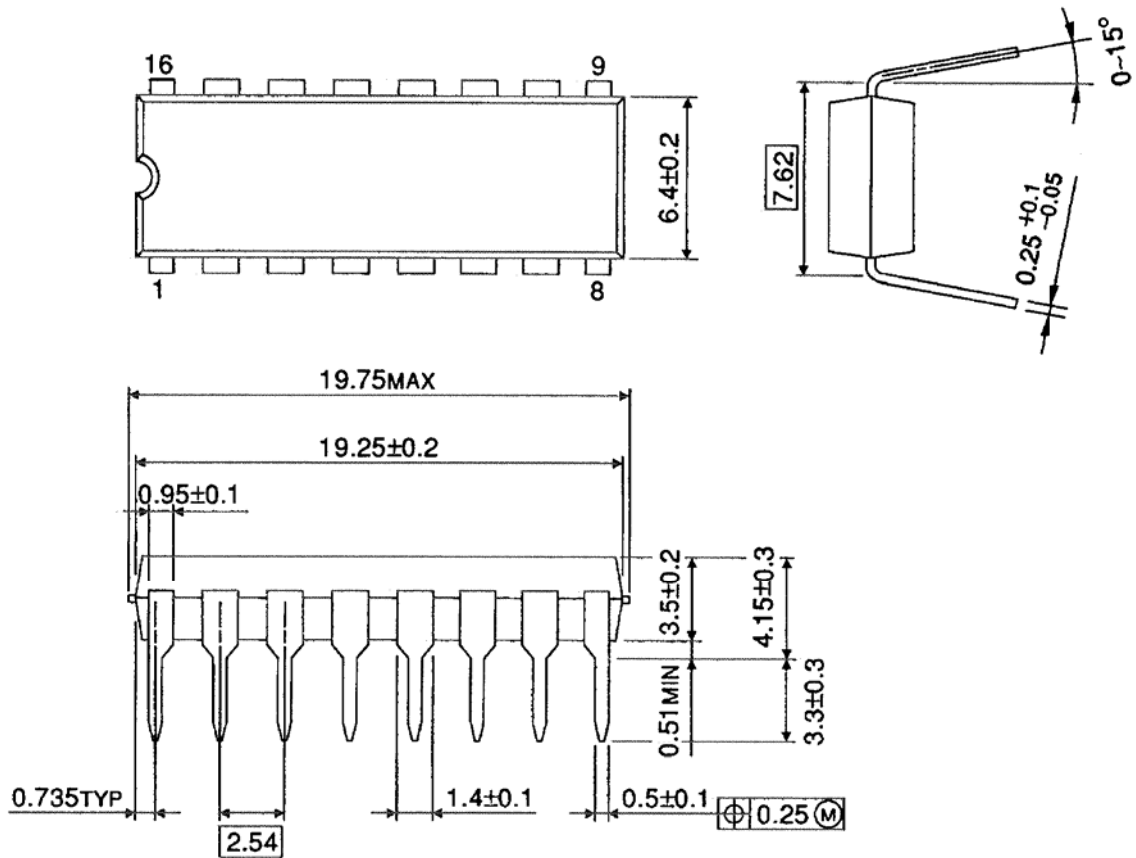


Weight: 0.79 g (typ.)

Package Dimensions

DIP16-P-300-2.54A

Unit : mm



Weight: 1.11 g (typ.)

Notes on Contents

1. Block Diagrams

Some of the functional blocks, circuits, or constants may be omitted or simplified in the block diagram for explanatory purposes.

2. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

3. Timing Charts

Timing charts may be simplified for explanatory purposes.

4. Maximum Ratings

The absolute maximum ratings of a semiconductor device are a set of specified parameter values that must not be exceeded during operation, even for an instant.

If any of these ratings are exceeded during operation, the electrical characteristics of the device may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed.

Moreover, any exceeding of the ratings during operation may cause breakdown, damage and/or degradation in other equipment. Applications using the device should be designed so that no maximum rating will ever be exceeded under any operating conditions.

Before using, creating and/or producing designs, refer to and comply with the precautions and conditions set forth in this document.

5. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially in the mass production design phase.

In furnishing these examples of application circuits, Toshiba does not grant the use of any industrial property rights.

6. Test Circuits

Components in the test circuits are only used to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure in the application equipment.

Handling of the IC

Ensure that the product is installed correctly to prevent breakdown, damage and/or degradation in the product or equipment.

Overcurrent protection and heat protection circuits

These protection functions are intended only as a temporary means of preventing output short circuits or other abnormal conditions and are not guaranteed to prevent damage to the IC.

If the guaranteed operating ranges of this product are exceeded, these protection features may not operate and some output short circuits may result in the IC being damaged.

The overcurrent protection feature is intended to protect the IC from temporary short circuits only.

Short circuits persisting over long periods may cause excessive stress and damage the IC. Systems should be configured so that any overcurrent condition will be eliminated as soon as possible.

Counter-electromotive force

When the motor reverses or stops, the effect of counter-electromotive force may influence the current to flow to the power source.

If the power supply is not equipped with sink capability, the power and output pins may exceed the maximum rating.

The counter-electromotive force of the motor will vary depending on the conditions of use and the features of the motor. Therefore make sure there will be no damage to or operational problem in the IC, and no damage to or operational errors in peripheral circuits caused by counter-electromotive force.

RESTRICTIONS ON PRODUCT USE

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